

Title (en)

GLASS MATERIAL FOR USE AT HIGH FREQUENCIES

Title (de)

GLASMATERIAL FÜR HOCHFREQUENZANWENDUNGEN

Title (fr)

MATERIAU VITREUX POUR APPLICATIONS HAUTES FREQUENCES

Publication

**EP 1506578 A2 20050216 (DE)**

Application

**EP 03755118 A 20030523**

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- EP 0303907 W 20030415

Abstract (en)

[origin: US2007166520A1] To improve the radio-frequency properties of radio-frequency substrates or radio-frequency conductor arrangements, the invention proposes a glass material for producing insulation layers for radio-frequency substrates or radio-frequency conductor arrangements, which, as an applied layer, in particular with a layer thickness in the range between 0.05  $\mu\text{m}$  and 5 mm, has a loss factor tan delta of less than or equal to  $70 \times 10^{-4}$  in at least a frequency range above 1 GHz.

IPC 1-7

**H01L 23/498**

IPC 8 full level

**H05K 3/46** (2006.01); **B81C 1/00** (2006.01); **C03B 19/00** (2006.01); **C03C 4/12** (2006.01); **C03C 14/00** (2006.01); **C03C 15/00** (2006.01); **C03C 17/02** (2006.01); **C03C 17/34** (2006.01); **C23C 14/10** (2006.01); **H01L 21/316** (2006.01); **H01L 21/50** (2006.01); **H01L 21/56** (2006.01); **H01L 21/768** (2006.01); **H01L 23/10** (2006.01); **H01L 23/29** (2006.01); **H01L 23/31** (2006.01); **H01L 23/48** (2006.01); **H01L 23/498** (2006.01); **H01L 23/532** (2006.01); **H01L 23/66** (2006.01); **H01L 51/52** (2006.01); **H01P 11/00** (2006.01); **H05K 3/28** (2006.01)

CPC (source: EP US)

**C03B 19/00** (2013.01 - EP US); **C03C 3/083** (2013.01 - EP US); **C03C 3/089** (2013.01 - EP US); **C03C 4/12** (2013.01 - EP US); **C03C 14/006** (2013.01 - EP US); **C03C 15/00** (2013.01 - EP US); **C03C 17/02** (2013.01 - EP US); **C03C 17/34** (2013.01 - EP US); **C23C 14/10** (2013.01 - EP US); **H01L 21/02129** (2013.01 - US); **H01L 21/02161** (2013.01 - US); **H01L 21/02263** (2013.01 - EP US); **H01L 21/31616** (2013.01 - US); **H01L 21/31625** (2013.01 - US); **H01L 21/50** (2013.01 - EP US); **H01L 21/56** (2013.01 - EP US); **H01L 23/10** (2013.01 - EP US); **H01L 23/291** (2013.01 - EP US); **H01L 23/314** (2013.01 - EP US); **H01L 23/481** (2013.01 - US); **H01L 23/5329** (2013.01 - EP); **H01L 23/66** (2013.01 - EP US); **H01L 24/97** (2013.01 - EP US); **H01P 3/003** (2013.01 - EP US); **H01P 11/003** (2013.01 - EP US); **H05K 3/467** (2013.01 - EP US); **H10K 50/8426** (2023.02 - US); **H10K 50/844** (2023.02 - US); **H10K 50/846** (2023.02 - US); **C03C 2214/16** (2013.01 - EP US); **C03C 2217/21** (2013.01 - EP US); **C03C 2218/15** (2013.01 - EP US); **C03C 2218/32** (2013.01 - EP US); **C03C 2218/328** (2013.01 - EP US); **C03C 2218/33** (2013.01 - EP US); **C03C 2218/355** (2013.01 - EP US); **H01L 21/02129** (2013.01 - EP); **H01L 21/02161** (2013.01 - EP); **H01L 23/481** (2013.01 - EP); **H01L 23/49894** (2013.01 - EP US); **H01L 2223/6627** (2013.01 - EP US); **H01L 2224/97** (2013.01 - EP US); **H01L 2924/01004** (2013.01 - EP US); **H01L 2924/01005** (2013.01 - EP US); **H01L 2924/01006** (2013.01 - EP US); **H01L 2924/01011** (2013.01 - EP US); **H01L 2924/01013** (2013.01 - EP US); **H01L 2924/01015** (2013.01 - EP US); **H01L 2924/01019** (2013.01 - EP US); **H01L 2924/0102** (2013.01 - EP US); **H01L 2924/01027** (2013.01 - EP US); **H01L 2924/01033** (2013.01 - EP US); **H01L 2924/0106** (2013.01 - EP US); **H01L 2924/01068** (2013.01 - EP US); **H01L 2924/01072** (2013.01 - EP US); **H01L 2924/01078** (2013.01 - EP US); **H01L 2924/01082** (2013.01 - EP US); **H01L 2924/04953** (2013.01 - EP US); **H01L 2924/09701** (2013.01 - EP US); **H01L 2924/12041** (2013.01 - EP US); **H01L 2924/12044** (2013.01 - EP US); **H01L 2924/15311** (2013.01 - EP US); **H01L 2924/1903** (2013.01 - EP US); **H01L 2924/19033** (2013.01 - EP US); **H01L 2924/19041** (2013.01 - EP US); **H01L 2924/19042** (2013.01 - EP US); **H01L 2924/19043** (2013.01 - EP US); **H01L 2924/351** (2013.01 - EP US); **H05K 3/28** (2013.01 - EP US); **H05K 2201/0179** (2013.01 - EP US); **H10K 50/805** (2023.02 - US); **H10K 50/85** (2023.02 - US); **Y02P 40/57** (2015.11 - EP US); **Y10T 428/24917** (2015.01 - EP US)

C-Set (source: EP US)

1. **H01L 2224/97 + H01L 2924/15311**
2. **H01L 2924/351 + H01L 2924/00**

Citation (examination)

- US 6329702 B1 20011211 - GRESHAM ROBERT IAN [US], et al
- US 5696466 A 19971209 - LI PING [US]
- US 5639325 A 19970617 - STEVENS RALPH E [US], et al
- See also references of WO 03100846A2

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DOCDB simple family (publication)

**US 2007166520 A1 20070719; US 8273671 B2 20120925**; AU 2003247287 A1 20031212; AU 2003247287 A8 20031212; CN 1656612 A 20050817; EP 1506578 A2 20050216; JP 2005595108 A 20051117; JP 2006513558 A 20060420; JP 2010153927 A 20100708; JP 5027992 B2 20120919; WO 03100846 A2 20031204; WO 03100846 A3 20040318

DOCDB simple family (application)

**US 51487603 A 20030523**; AU 2003247287 A 20030523; CN 03811821 A 20030523; EP 0305414 W 20030523; EP 03755118 A 20030523; JP 2004508402 A 20030523; JP 2004508410 A 20030523; JP 2010086382 A 20100402